

Vishay Semiconductors

High Intensity LED in Ø 3 mm Tinted Diffused Package



DESCRIPTION

This device has been designed to meet the increasing demand for AllnGaP technology for general indicating and lighting purposes.

It is housed in a 3 mm diffused plastic package. The wide viewing angle of these devices provides a high brightness across a large field of view.

All packing units are categorized in luminous intensity groups. That allows users to assemble LEDs with uniform appearance.

PRODUCT GROUP AND PACKAGE DATA

• Product group: LED · Package: 3 mm

· Product series: standard • Angle of half intensity: ± 30°

FEATURES

- AllnGaP technology
- Standard Ø 3 mm (T-1) package
- · Small mechanical tolerances
- · Suitable for DC and high peak current
- · Small viewing angle
- · Very high intensity
- · Luminous intensity categorized
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





HALOGEN FREE

GREEN

APPLICATIONS

- · Status lights
- · Off / on indicator
- · Background illumination
- · Readout lights
- Maintenance lights
- · Legend light

PARTS TABLE														
PART	COLOR	LUMINOUS INTENSITY (mcd)		at I _F	WAVELENGTH (nm)		at I _F	FORWARD VOLTAGE (V)		at I _F (mA)	TECHNOLOGY			
		MIN.	TYP.	MAX.	(IIIA)	MIN.	TYP.	MAX.	(HIIA)	MIN.	TYP.	MAX.	(IIIA)	
TLHK44R1S2	Red	112	180	280	20	-	630	ı	20	-	1.9	2.6	20	AllnGaP on GaAs

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) TLHK44R1S2							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
Reverse voltage (1)		V _R	5	V			
DC forward current	T _{amb} ≤ 60 °C	I _F	30	mA			
Surge forward current	t _p ≤ 10 μs	I _{FSM}	0.1	Α			
Power dissipation	T _{amb} ≤ 60 °C	P _V	80	mW			
Junction temperature		T _j	100	°C			
Operating temperature range		T _{amb}	-40 to +100	°C			
Storage temperature range		T _{stg}	-55 to +100	°C			
Soldering temperature	$t \le 5$ s, 2 mm from body	T _{sd}	260	°C			
Thermal resistance junction/ambient		R _{thJA}	400	K/W			

Note

⁽¹⁾ Driving the LED in reverse direction is suitable for a short term application



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OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25$ °C, unless otherwise specified) TLHK44R1S2, RED							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Luminous intensity (1)	I _F = 20 mA	I _V	112	180	280	mcd	
Dominant wavelength	I _F = 20 mA	λ_{d}	-	630	-	nm	
Peak wavelength	I _F = 20 mA	λρ	-	643	-	nm	
Angle of half intensity	I _F = 20 mA	φ	-	± 30	-	deg	
Forward voltage	I _F = 20 mA	V _F	-	1.9	2.6	V	
Reverse voltage	I _R = 10 μA	V _R	5	-	-	V	
Junction capacitance	V _R = 0, f = 1 MHz	Cj	-	15	-	pF	

Note

⁽¹⁾ In one packing unit $I_{Vmax.}/I_{Vmin.} \le 1.6$

LUMINOUS INTENSITY CLASSIFICATION							
GROUP	LIGHT INTENSITY (mcd)						
STANDARD	OPTIONAL	MIN.	MAX.				
R	1	112	140				
n	2	140	180				
S	1	180	224				
3	2	224	280				

Note

 Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of ± 11 %.

The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each bag (there will be no mixing of two groups on each bag).

In order to ensure availability, single brightness groups will not be orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one bag.

In order to ensure availability, single wavelength groups will not be orderable.

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

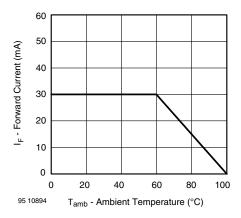


Fig. 1 - Forward Current vs. Ambient Temperature for InGaN

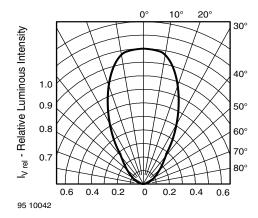


Fig. 2 - Relative Luminous Intensity vs. Angular Displacement





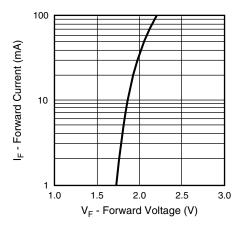


Fig. 3 - Forward Current vs. Forward Voltage

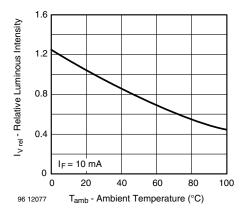


Fig. 4 - Rel. Luminous Intensity vs. Ambient Temperature

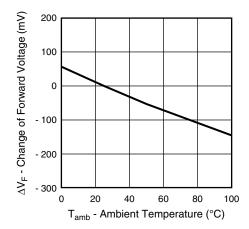


Fig. 5 - Change of Forward Voltage vs. Ambient Temperature

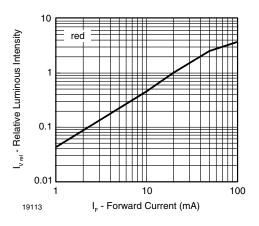


Fig. 6 - Relative Luminous Intensity vs. Forward Current

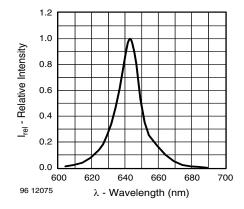
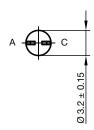
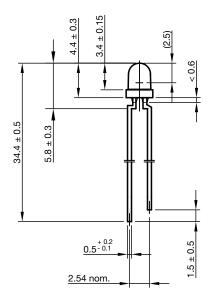


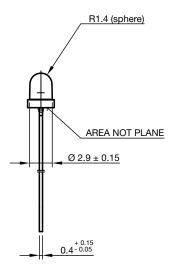
Fig. 7 - Relative Intensity vs. Wavelength

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PACKAGE DIMENSIONS in millimeters







technical drawings according to DIN specifications

Drawing-No.: 6.544-5255.01-4

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